



US00D754010S

(12) **United States Design Patent**
Shen

(10) **Patent No.:** **US D754,010 S**

(45) **Date of Patent:** **** Apr. 19, 2016**

(54) **DIGITAL MULTIMETER**

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(74) *Attorney, Agent, or Firm* — Seed IP Law Group PLLC

(72) Inventor: **Yurui Shen**, Shanghai (CN)

(57) **CLAIM**

(73) Assignee: **Danaher (Shanghai) Industrial Instrumentation Technologies R&D Co., Ltd.**, Shanghai (CN)

The ornamental design for a digital multimeter, as shown and described.

(**) Term: **14 Years**

(21) Appl. No.: **29/519,136**

(22) Filed: **Mar. 2, 2015**

DESCRIPTION

Related U.S. Application Data

(63) Continuation of application No. 29/476,733, filed on Dec. 16, 2013, now Pat. No. Des. 723,401.

FIG. 1 is a front elevation view of a digital multimeter showing my new design;

FIG. 2 is a rear elevation view thereof;

FIG. 3 is a left side elevation view thereof;

FIG. 4 is a right side elevation view thereof;

FIG. 5 is a top plan view thereof;

FIG. 6 is a bottom plan view thereof;

FIG. 7 is a bottom front right perspective view thereof;

FIG. 8 is a front elevation view of another embodiment of a digital multimeter showing my new design;

FIG. 9 is a rear elevation view thereof;

FIG. 10 is a left side elevation view thereof;

FIG. 11 is a right side elevation view thereof;

FIG. 12 is a top plan view thereof;

FIG. 13 is a bottom plan view thereof;

FIG. 14 is a bottom front right perspective view thereof;

FIG. 15 is a front elevation view of another embodiment of a digital multimeter showing my new design;

FIG. 16 is a rear elevation view thereof;

FIG. 17 is a left side elevation view thereof;

FIG. 18 is a right side elevation view thereof;

FIG. 19 is a top plan view thereof;

FIG. 20 is a bottom plan view thereof; and,

FIG. 21 is a bottom front right perspective view thereof.

The broken line showing of structural features is included for the purpose of illustrating non-claimed subject matter and forms no part of the claimed design.

Foreign Application Priority Data

Jun. 19, 2013 (CN) 2013 3 0263248

(51) **LOC (10) Cl.** **10-04**

(52) **U.S. Cl.**
USPC **D10/78**

(58) **Field of Classification Search**
USPC D10/78

CPC G01R 1/22; G01R 1/04; G01R 15/125;
G01R 15/181; G01R 15/186; G01R 15/12;
G01R 15/04; G01R 15/06; G01R 19/2503;
G01R 1/20; G01R 1/203; G01R 1/206;
G01R 1/24; G01R 1/26; G01D 11/24; G06F
17/00

See application file for complete search history.

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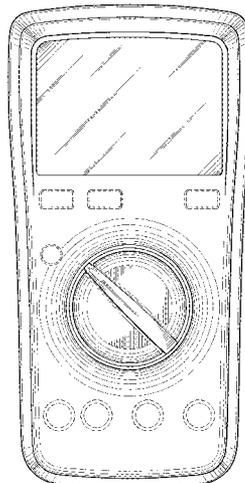
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1 Claim, 15 Drawing Sheets



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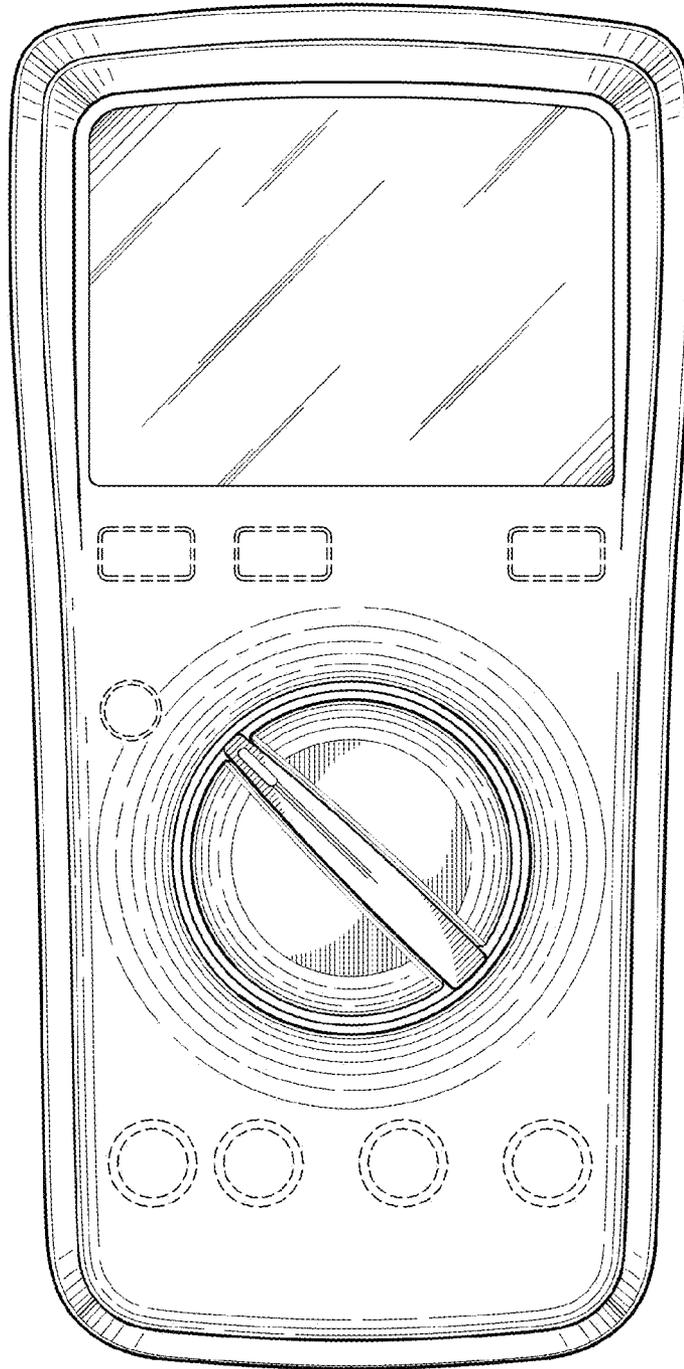


Fig. 1.

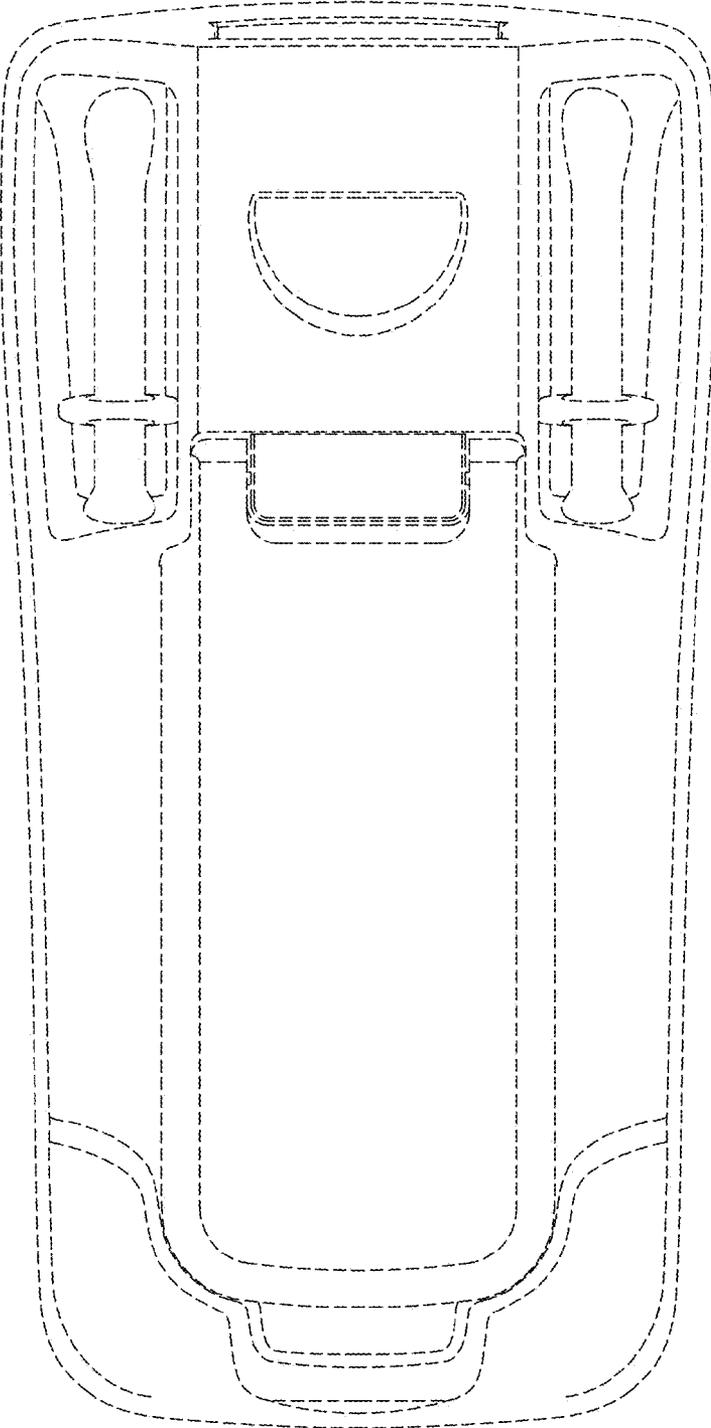


Fig. 2.

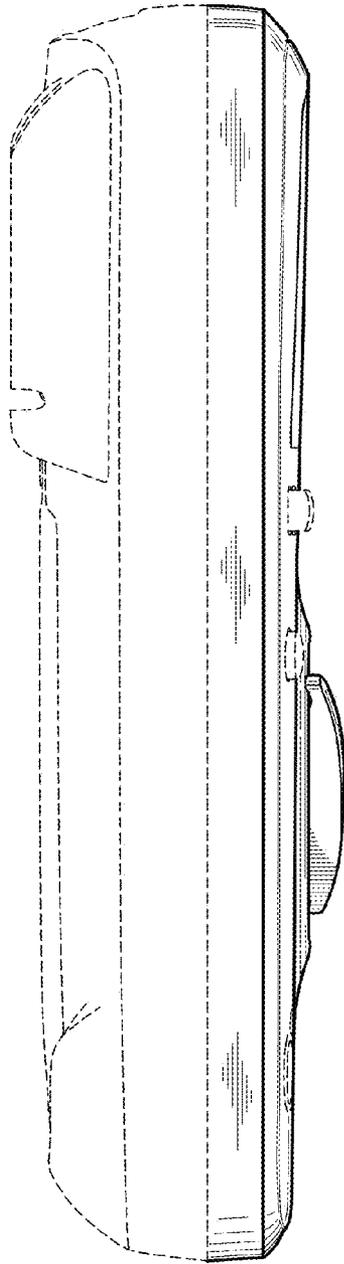


Fig. 3.

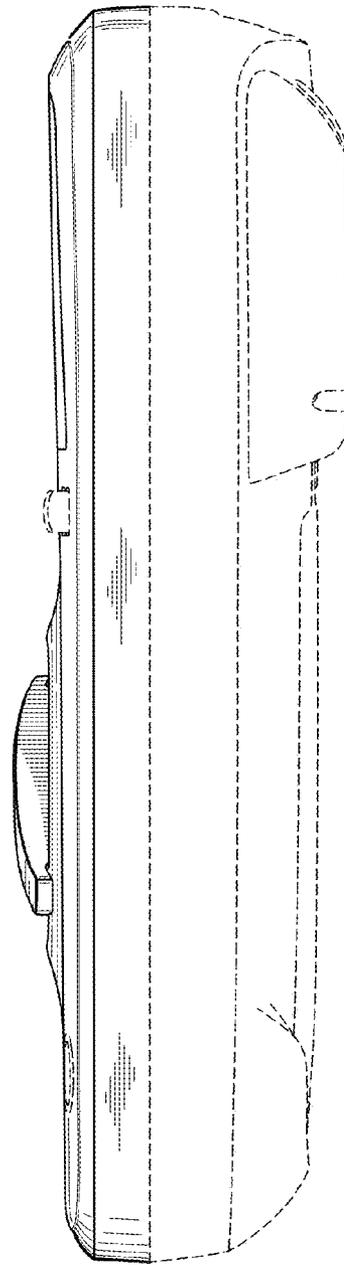


Fig. 4.

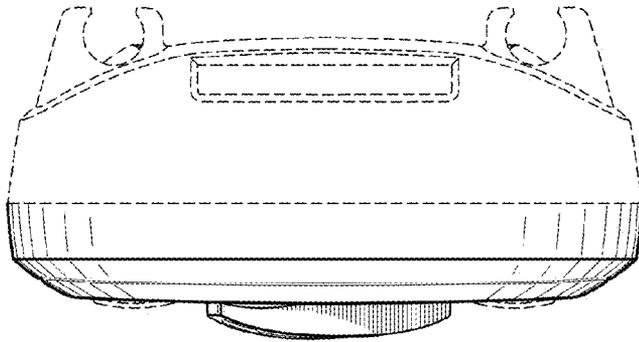


Fig. 5.

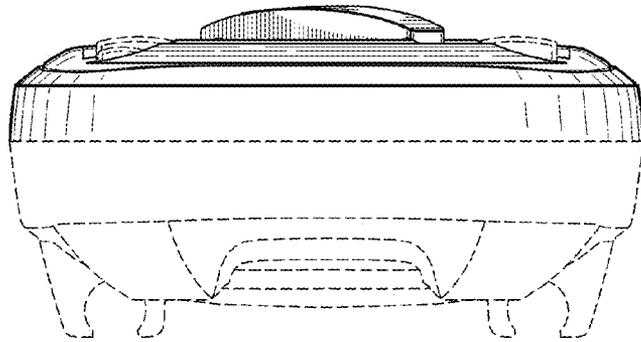


Fig. 6.

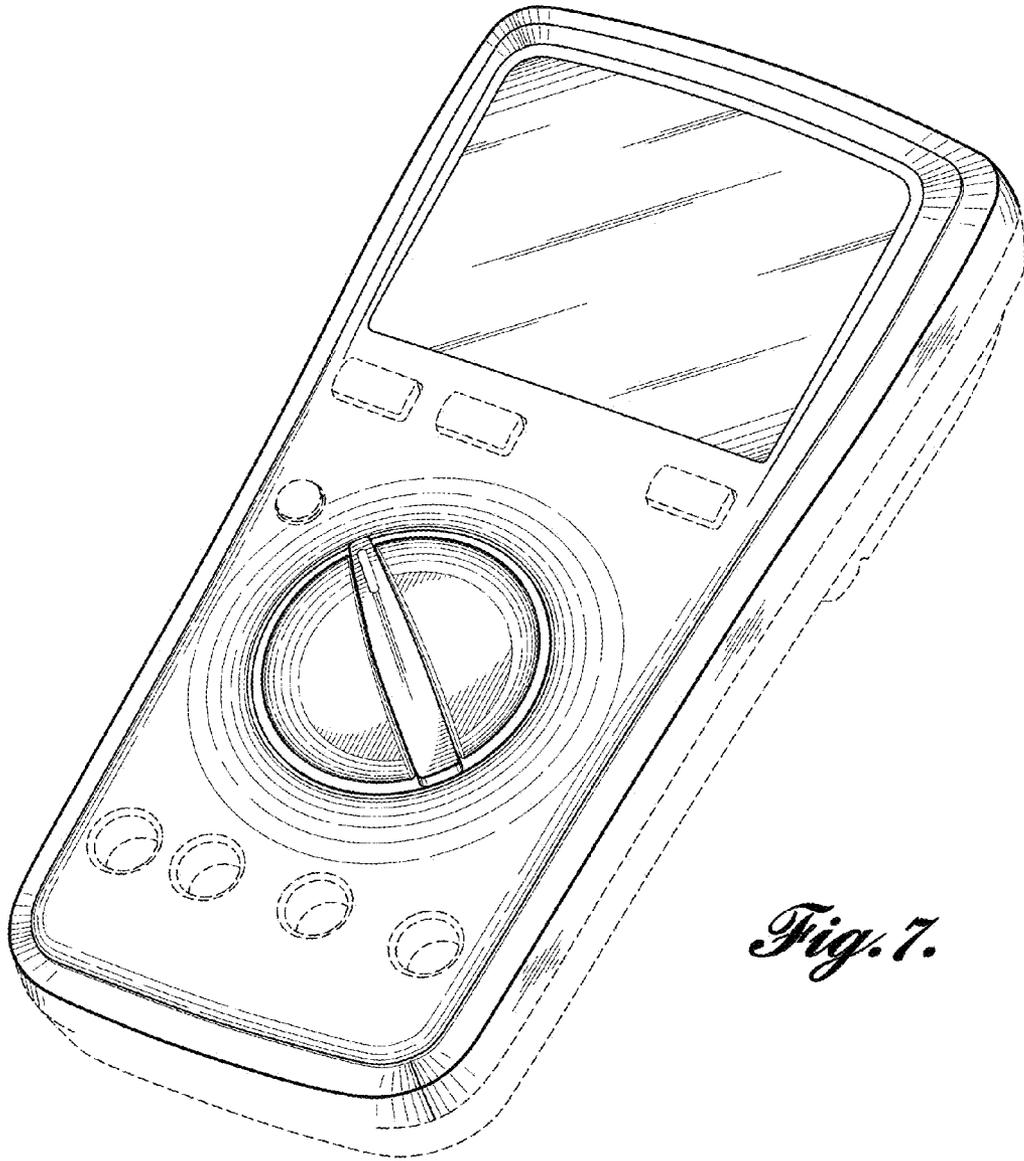


Fig. 7.

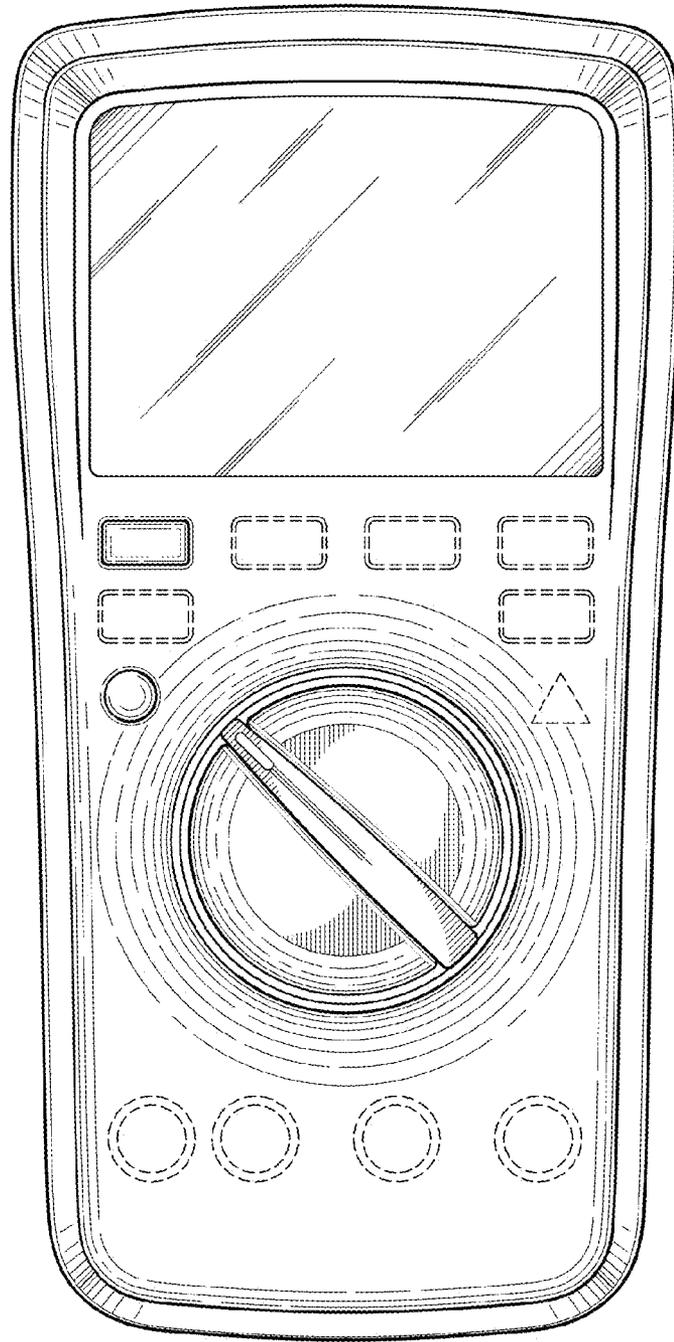


Fig. 8.

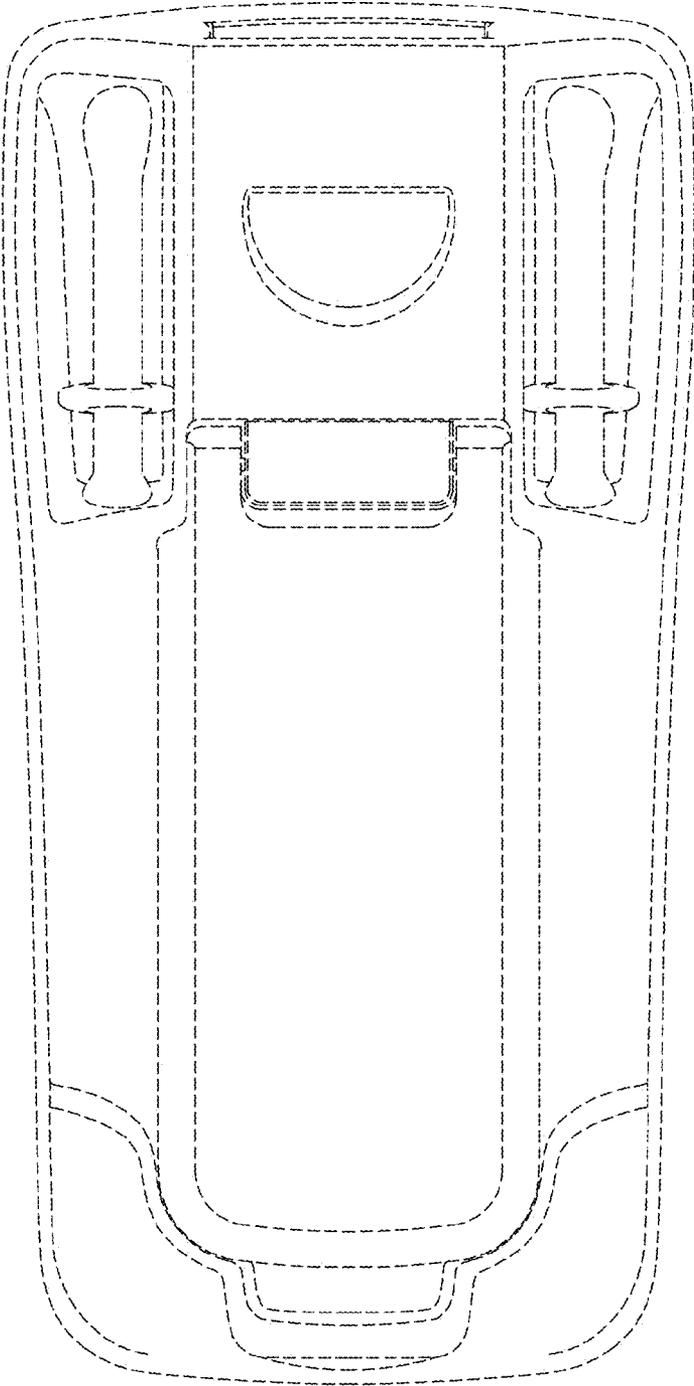


Fig. 9.

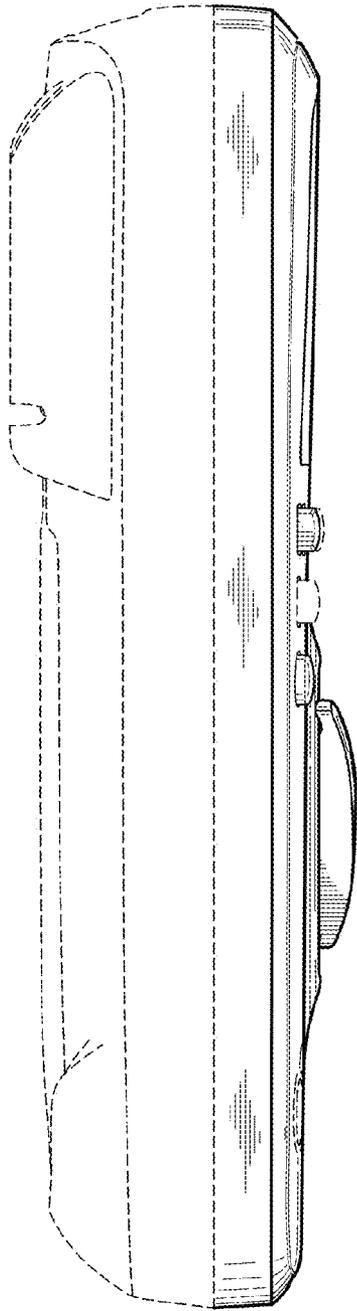


Fig. 10.

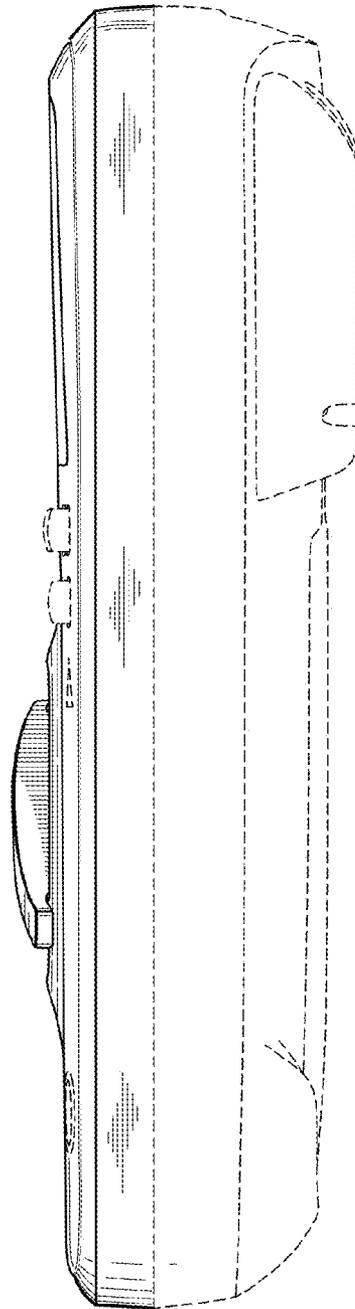


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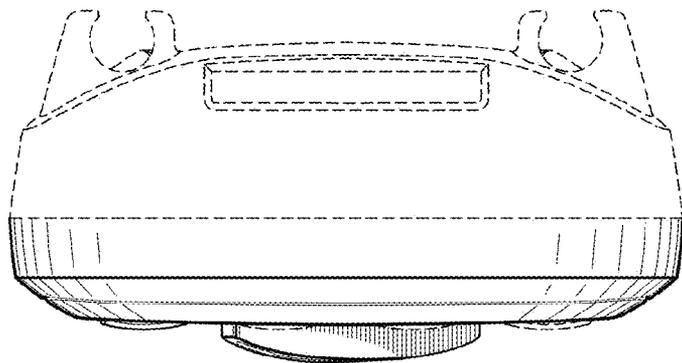


Fig. 12.

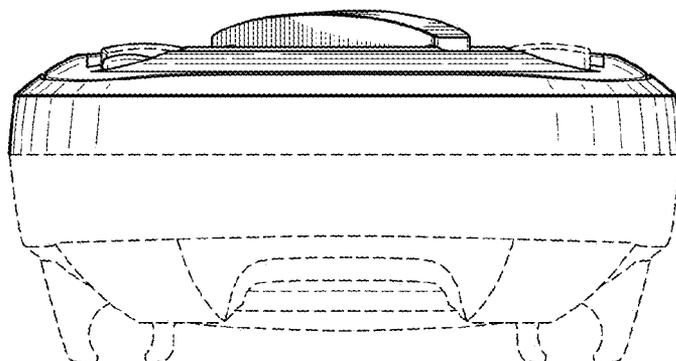


Fig. 13.

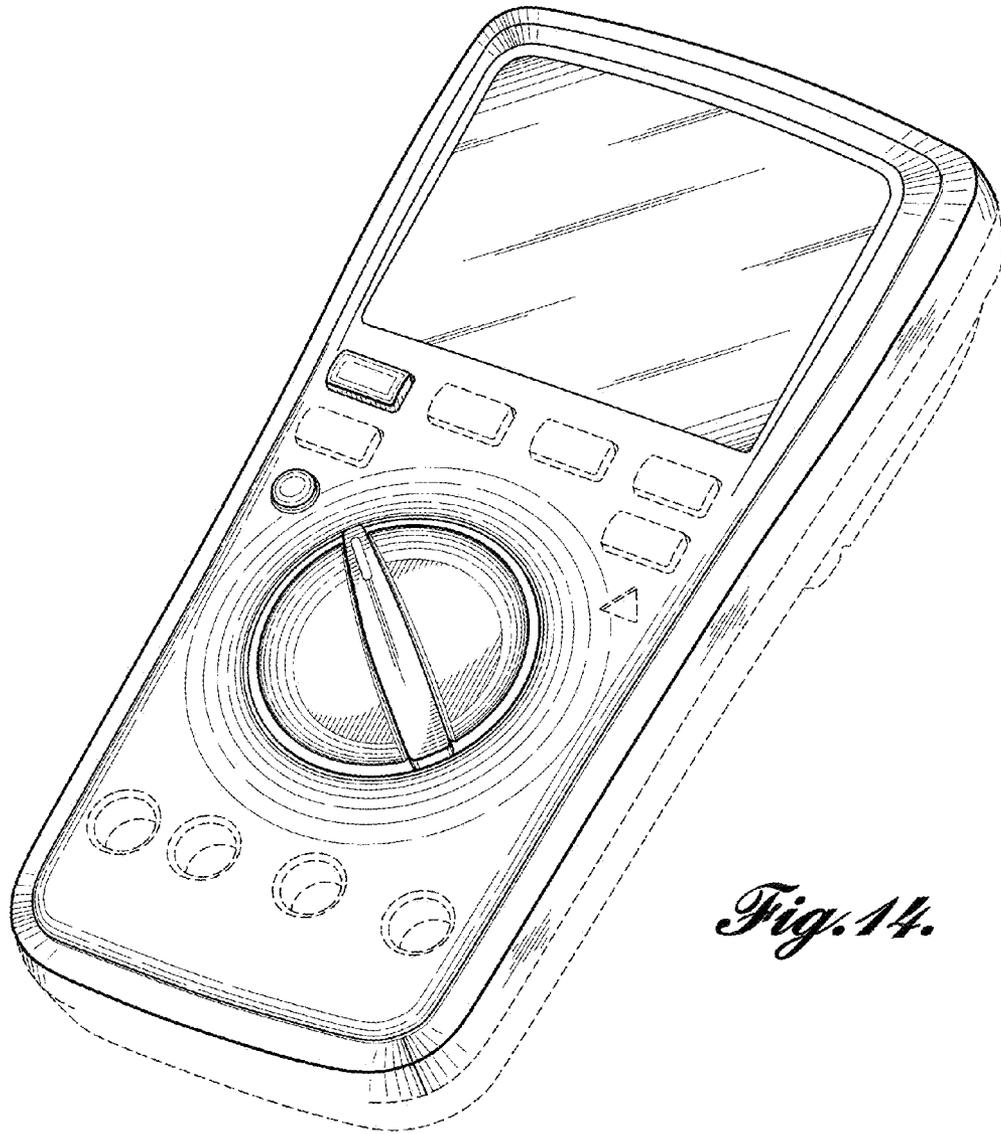


Fig. 14.

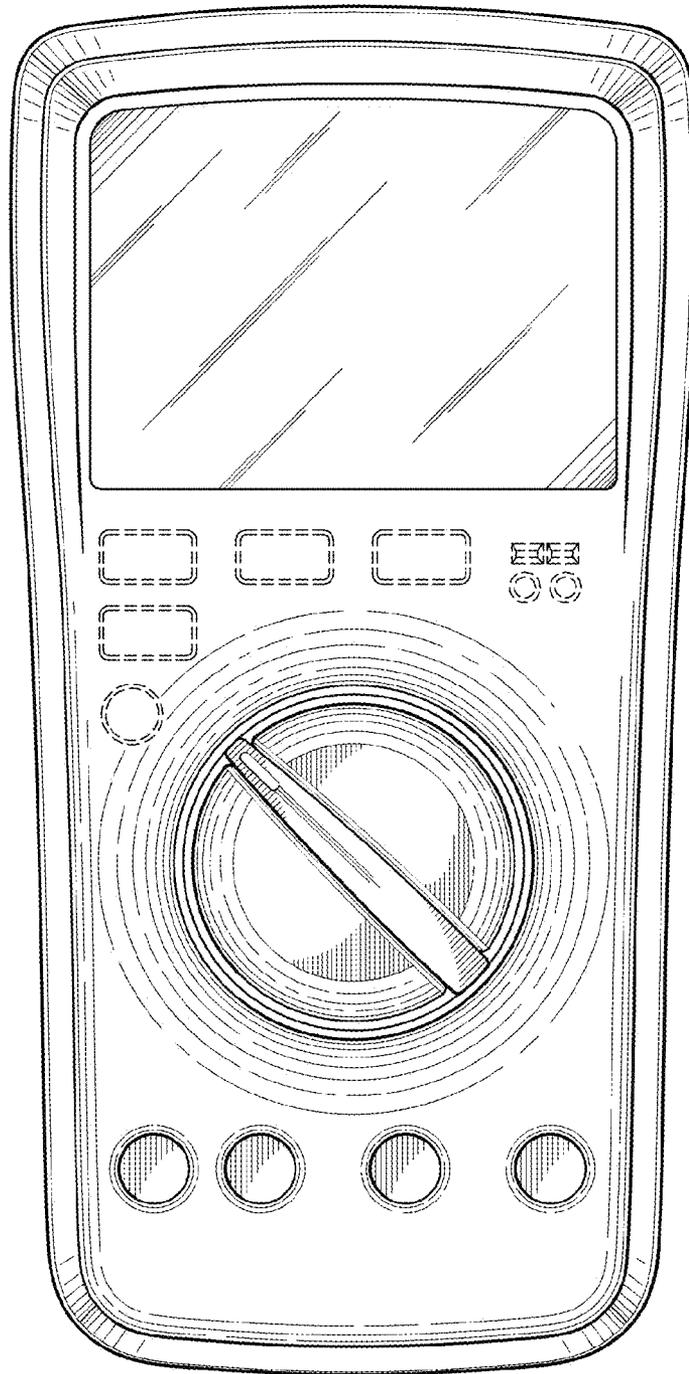


Fig. 15.

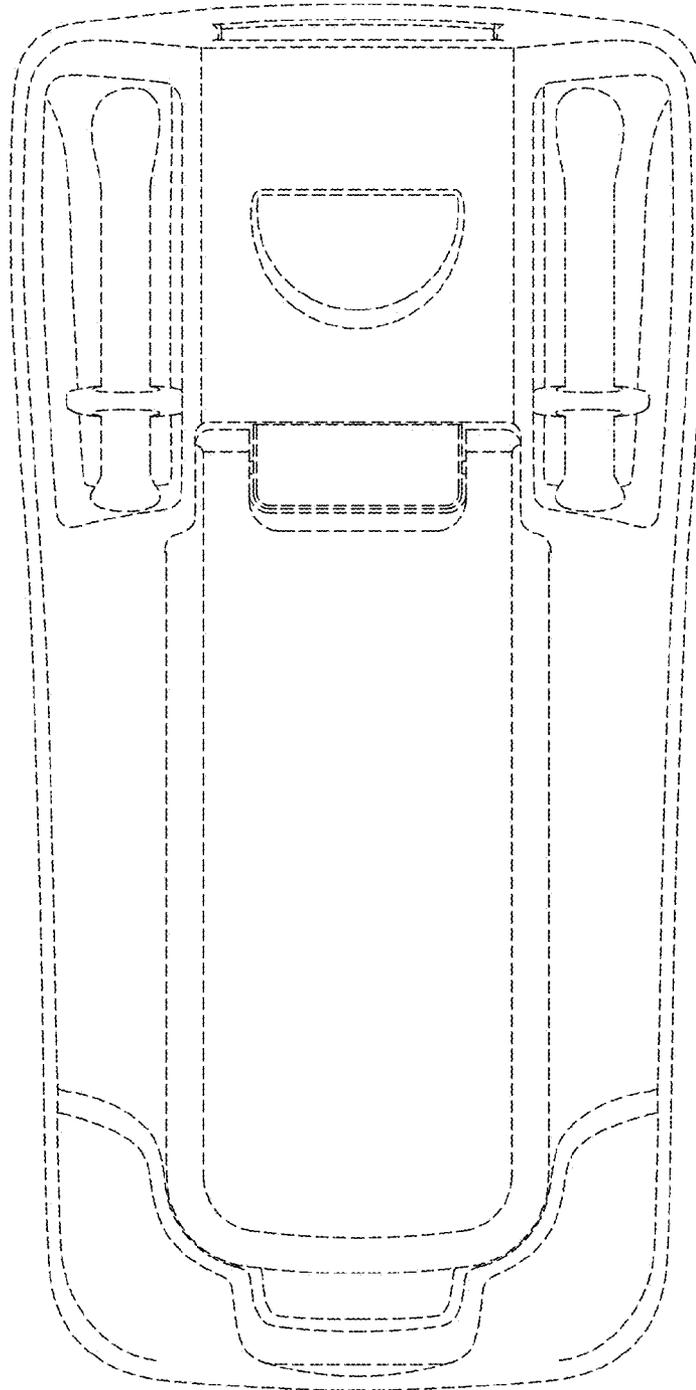


Fig. 16.

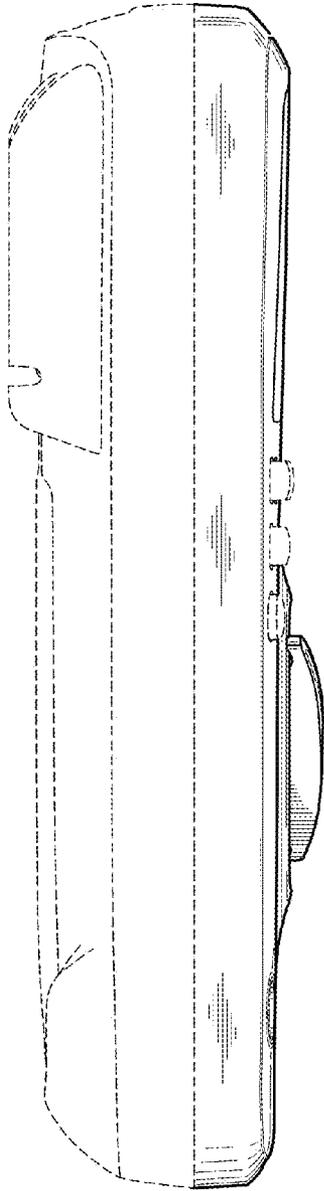


Fig. 17.

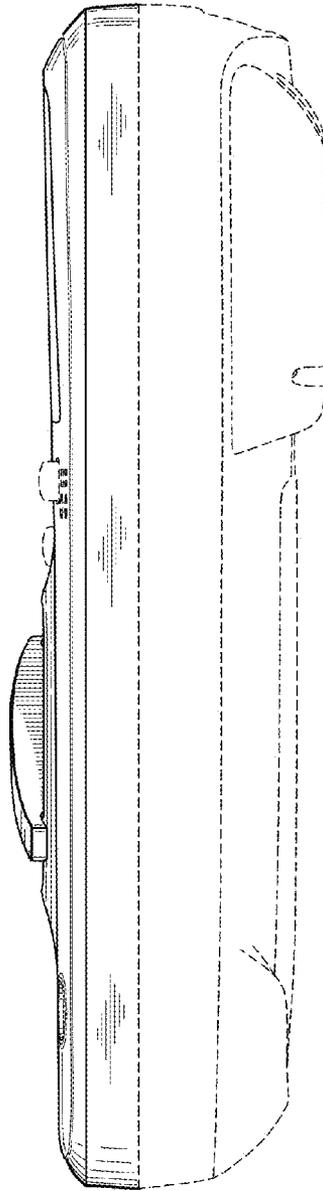


Fig. 18.

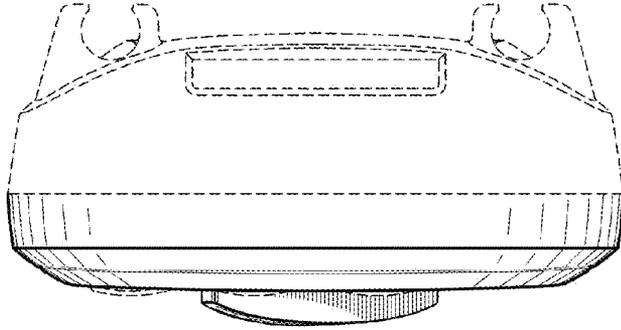


Fig. 19.

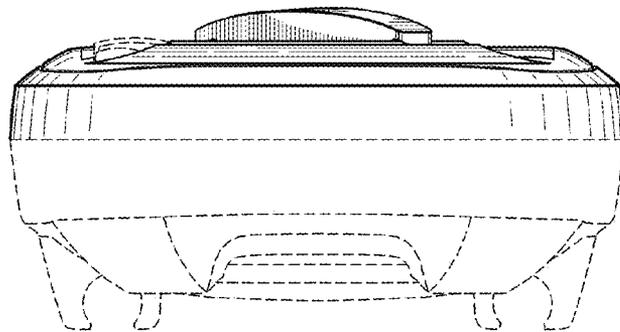


Fig. 20.

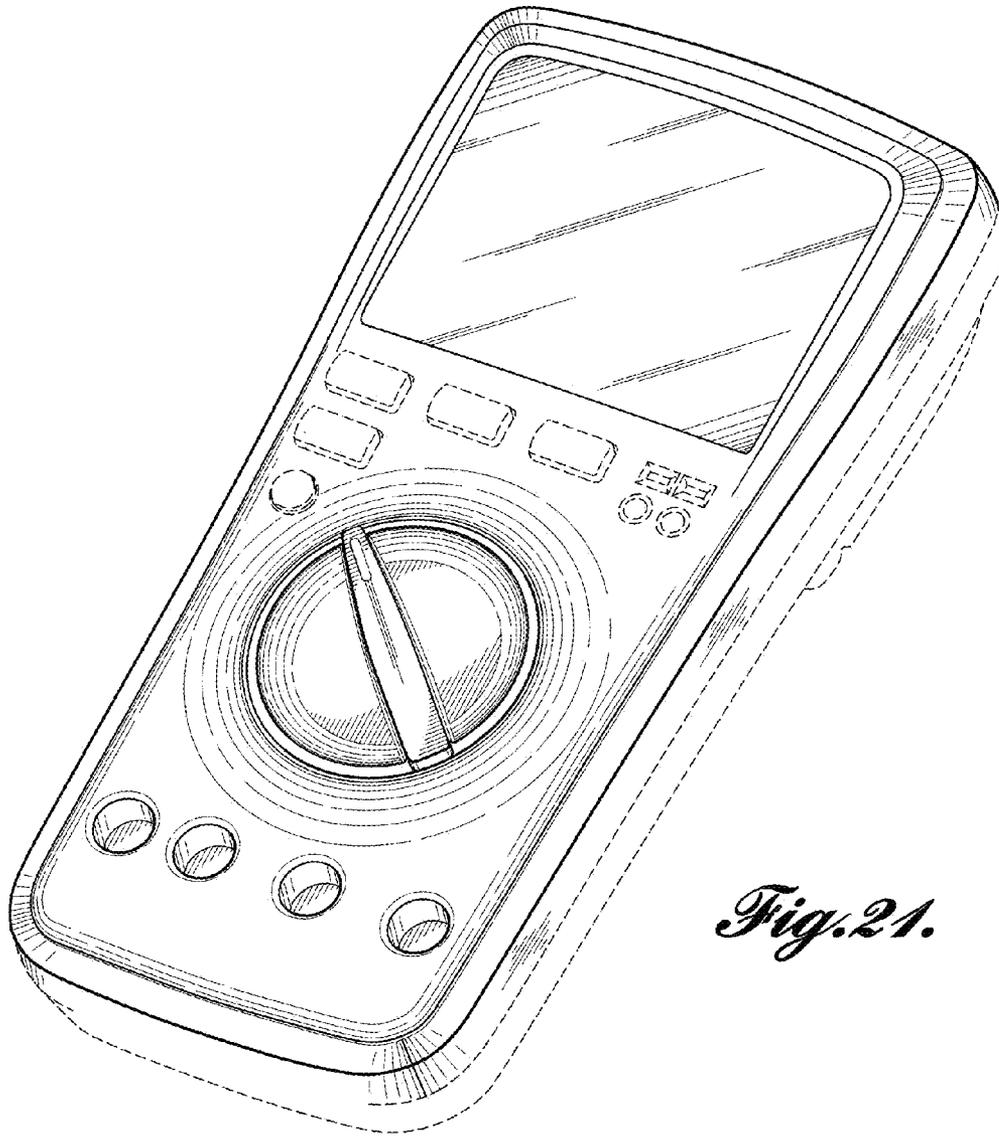


Fig. 21.